

RevisionHistory

512 Kb x16 Pseudo Static RAM

48ball-FPBGA

Revision	Details	Date
Rev 1.0	Preliminary datasheet	Aug. 2018

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GENERAL DESCRIPTION

The AS1C512K16P-70BIN is 8,388,608 bits of Pseudo SRAM which uses DRAM type memory cells, but this device has refresh-free operation and extreme low power consumption technology. Furthermore the interface is compatible to a low power Asynchronous type SRAM. The AS1C512K16P-70BIN is organized as 524,288 Words x 16 bit.

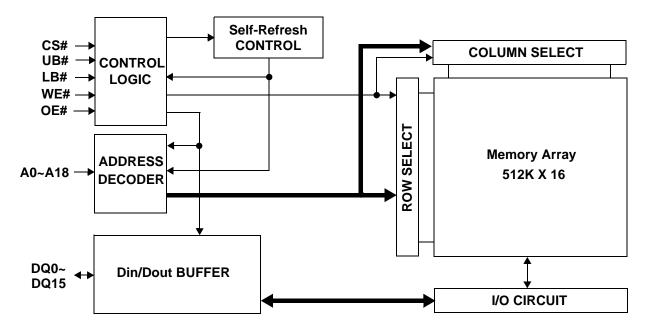
FEATURES

- Organization :512K x16
- Address access speed 70ns
- Power Supply Voltage : 2.6 ~ 3.3V
- Separated I/O power(VccQ) & Core power(Vcc)
- Three state outputs
- Byte read/write control by UB# / LB#
- Auto-TCSR for power saving
- Package type : 48-FPBGA 6.0x7.0
- Operating Temperature
- . Industrial : -40 $\,^\circ\!\!\mathbb{C}$ ~ 85 $\,^\circ\!\!\mathbb{C}$

PRODUCT FAMILY

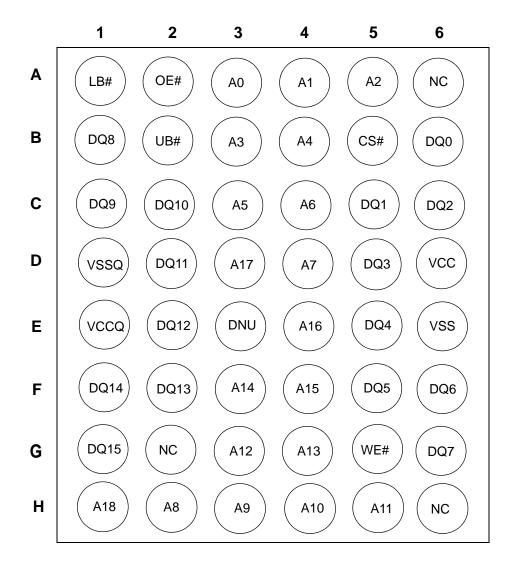
		Power Supply	Speed (t _{RC})	Power Dissipation			
Part Number	Operating Temp.				Operating I _{CC} (Max.)		
				Standby (I _{SB} , Max.)	I _{CC1} (f = 1MHz)	I _{CC2} (f = f _{max})	
AS1C512K16P-70BIN	-40 ℃to 85 ℃	2.6V to 3.3V	70ns	120uA	5mA	25mA	

FUNCTION BLOCK DIAGRAM





PIN DESCRIPTION (48-FPBGA-6.00x7.00)



TOP VIEW (Ball Down)

Name	Function	Name	Function
CS#	Chip select input	LB#	Lower byte (DQ _{0~7})
OE#	Output enable input	UB#	Upper byte (DQ _{8~15})
WE#	Write enable input	VCC	Power supply
DQ ₀₋₁₅	Data in-out	VCCQ	I/O power supply
A ₀₋₁₈	Address inputs	VSS(Q)	Ground
DNU	Do not use	NC	No connection



ABSOLUTE MAXIMUM RATINGS 1)

Parameter	Symbol	Ratings	Unit	
Voltage on Any Pin Relative to Vss	VIN, VOUT	-0.2 to VCCQ+0.3	V	
Voltage on Vcc supply relative to Vss	V _{CC} , V _{CCQ}	-0.2 ²⁾ to VCCQ+0.3V	V	
Power Dissipation		PD	1.0	W
Storage Temperature		T _{STG}	-65 to 150	°C
Operating Temperature	Industrial	T _A	-40 to 85	°C

1. Stresses greater than those listed above "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation should be restricted to recommended operating condition. Exposure to absolute maximum rating conditions for

extended periods may affect reliability.

2. Undershoot at power-off : -1.0V in case of pulse width < 20ns

FUNCTIONAL DESCRIPTION

CS#	OE#	WE#	LB#	UB#	DQ _{0~7}	DQ _{8~15}	Mode	Power
Н	Х	Х	Х	Х	High-Z	High-Z	Deselected	Stand by
L	Н	Н	L	Х	High-Z	High-Z	Output Disabled	Active
L	Н	Н	Х	L	High-Z	High-Z	Output Disabled	Active
L	L	Н	L	Н	Data Out	High-Z	Lower Byte Read	Active
L	L	Н	Н	L	High-Z	Data Out	Upper Byte Read	Active
L	L	Н	L	L	Data Out	Data Out	Word Read	Active
L	Х	L	L	Н	Data In	High-Z	Lower Byte Write	Active
L	Х	L	Н	L	High-Z	Data In	Upper Byte Write	Active
L	Х	L	L	L	Data In	Data In	Word Write	Active

Note:

1. X means don't care. (Must be low or high state)



RECOMMENDED DC OPERATING CONDITIONS

Parameter	Symbol	Min	Тур	Max	Unit
Supply voltage	V _{CC}	2.6	3.0	3.3	V
Supply voltage	V _{CCQ}	2.6	3.0	3.3	V
Ground	V _{SS} , V _{SSQ}	0	0	0	V
Input high voltage	V _{IH}	0.8 * V _{CCQ}	-	$V_{CCQ} + 0.2^{1)}$	V
Input low voltage	V _{IL}	-0.2 ²⁾	-	0.2 * V _{CCQ}	V

1. Overshoot: Vcc +1.0 V in case of pulse width \leq 20ns

2. Undershoot: -1.0 V in case of pulse width ≤ 20 ns

3. Overshoot and undershoot are sampled, not 100% tested.

CAPACITANCE¹⁾ (f =1MHz, T_A =25°C)

ltem	Symbol	Test Condition	Min	Мах	Unit
Input capacitance	C _{IN}	V _{IN} =0V	-	8	pF
Input/Output capacitance	C _{IO}	V _{IO} =0V	-	8	pF

1. Capacitance is sampled, not 100% tested

DC AND OPERATING CHARACTERISTICS

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input leakage current	I _{LI}	$V_{\text{IN}} = V_{\text{SS}}$ to V_{CCQ} , $V_{\text{CC}} = V_{\text{CCmax}}$	-1	-	1	uA
Output leakage current	I _{LO}	$\label{eq:cs} \begin{array}{l} CS\#=V_{IH} \ , \ OE\#=V_{IH} \ or \ WE\#=V_{IL} \ , \\ V_{IO}=V_{SS} \ to \ V_{CCQ} \ , \ V_{CC=}V_{CCmax} \end{array}$	-1	-	1	uA
Average operating current	I _{CC1}	Cycle time = 1us, I_{IO} =0mA, 100% duty, CS# \leq 0.2V, V _{IN} \leq 0.2V or V _{IN} \geq V _{CCQ} -0.2V	-	-	5	mA
	I _{CC2}	Cycle time = Min, I_{IO} =0mA, 100% duty, CS#=V _{IL} , V _{IN} =V _{IL} or V _{IH}	-	-	25	mA
Output low voltage	V _{OL}	$I_{OL} = 0.5 \text{mA}, V_{CC} = V_{CCmin}$	-	-	0.2*V _{CCQ}	V
Output high voltage	V _{OH}	$I_{OH} = -0.5 \text{mA}, V_{CC=} V_{CCmin}$	0.8*V _{CCQ}	-	-	V
Standby current (CMOS)	I _{SB}	CS#≥V _{CCQ} -0.2V, Other inputs = 0 ~ V _{CCQ} (Typ. condition : V _{CC} =3.0V @ 25 ^o C) (Max. condition : V _{CC} =3.3V @ 85 ^o C)	-	-	120	uA

1. Maximum Icc specifications are tested with V_{CC} = V_{CCmax.}

ALLIANCE M E M O R Y

AS1C512K16P-70BIN

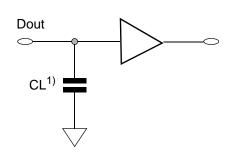
AC OPERATING CONDITIONS

Test Conditions (Test Load and Test Input/Output Reference)

Input Pulse Level : 0.2V to V_{CCQ} -0.2V Input Rise and Fall Time : 5ns Input and Output reference Voltage : $V_{CCQ}/2$ Output Load (See right) : $CL^{1)} = 30pF$

1. Including scope and Jig capacitance

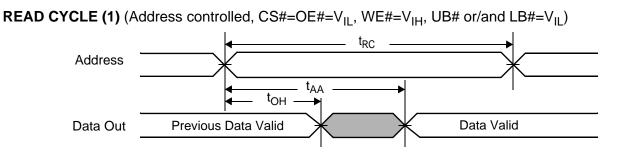
AC CHARACTERISTICS



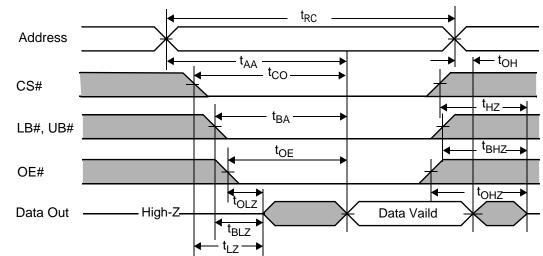
		Symbol	Sp	beed	Unit
	Parameter List	Symbol	Min	Max	
	Read Cycle Time	t _{RC}	70	10k	ns
	Address access time	t _{AA}	-	70	ns
	Chip enable to data output	t _{CO}	-	70	ns
	Output enable to valid output	t _{OE}	-	25	ns
	UB#, LB# enable to data output	t _{BA}	-	25	ns
Deed	Chip enable to low-Z output	t _{LZ}	10	-	ns
Read	UB#, LB# enable to low-Z output	t _{BLZ}	0	-	ns
	Output enable to low-Z output	t _{OLZ}	0	-	ns
	Chip disable to high-Z output	t _{HZ}	0	20	ns
	UB#, LB# disable to high-Z output	t _{BHZ}	0	20	ns
	Output disable to high-Z output	t _{OHZ}	0	20	ns
	Output hold from Address change	t _{OH}	5	-	ns
	Write Cycle Time	t _{WC}	70	10k	ns
	Chip enable to end of write	t _{CW}	60	-	ns
	Address setup time	t _{AS}	0	-	ns
	Address valid to end of write	t _{AW}	60	-	ns
	UB#, LB# valid to end of write	t _{BW}	60	-	ns
Write	Write pulse width	t _{WP}	50	-	ns
	Write recovery time	t _{WR}	0	-	ns
	Write to output high-Z	t _{WHZ}	0	20	ns
	Data to write time overlap	t _{DW}	20	-	ns
	Data hold from write time	t _{DH}	0	-	ns
	End write to output low-Z	t _{OW}	5	-	ns



TIMING DIAGRAMS



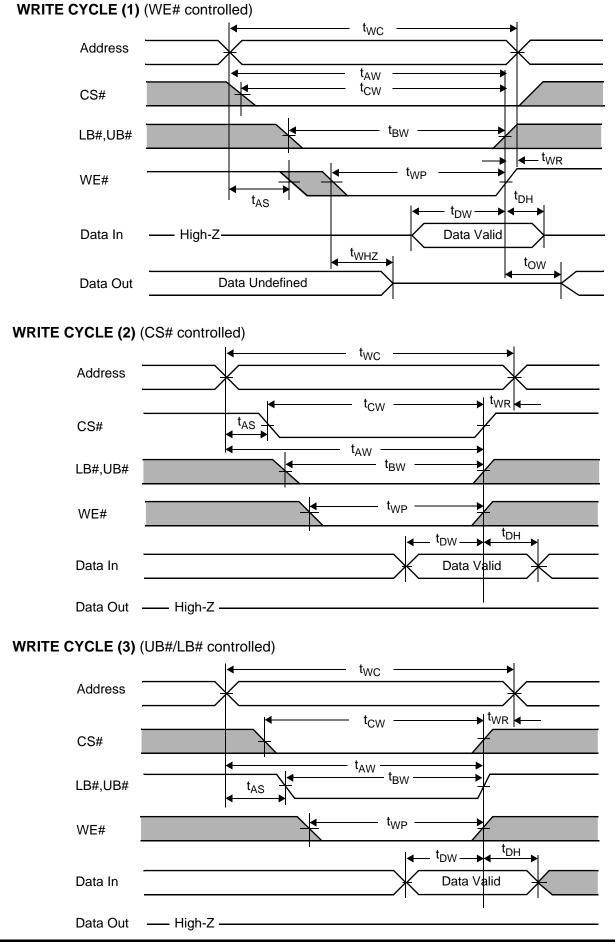
READ CYCLE (2) (WE#=V_{IH})



NOTES (READ CYCLE)

- 1. t_{HZ}, t_{BHZ} and t_{OHZ} are defined as the time at which the outputs achieve the open circuit conditions and are not referenced to output voltage levels.
- 2. Do not Access device with cycle timing shorter than t_{RC} for continuous periods > 10us.







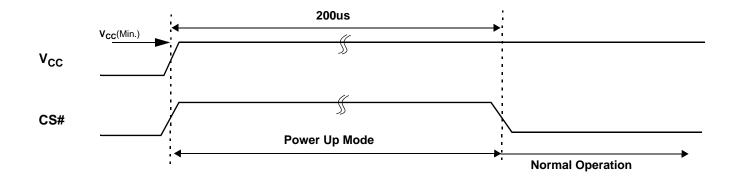


NOTES (WRITE CYCLE)

- 1. A write occurs during the overlap(t_{WP}) of low CS#, low WE# and low UB# or LB#. A write begins at the last transition among low CS# and low WE# with asserting UB# or LB# low for single byte operation or simultaneously asserting UB# and LB# low for word operation. A write ends at the earliest transition among high CS# and high WE#. The t_{WP} is measured from the beginning of write to the end of write.
- 2. t_{CW} is measured from CS# going low to end of write.
- 3. $t_{\mbox{AS}}$ is measured from the address valid to the beginning of write.
- 4. t_{WR} is measured from the end of write to the address change. t_{WR} applied in case a write ends as CS# or WE# going high.
- 5. Do not access device with cycle timing shorter than t_{WC} for continuous periods > 10us.



TIMING WAVEFORM OF POWER UP



NOTE (POWER UP)

1. After Vcc reaches Vcc(Min.), wait 200us with CS# high. Then you get into the normal operation.

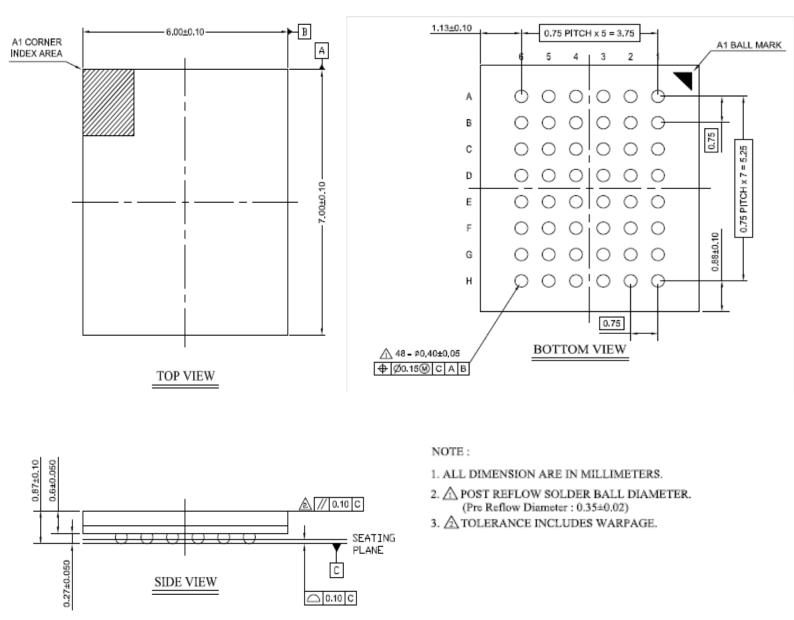


AS1C512K16P-70BIN

Unit: millimeters

PACKAGE DIMENSION

48 Ball Fine Pitch BGA (0.75mm ball pitch)





PART NUMBERING SYSTEM

AS1C	512K16P	-70	В		N	XX
PSEUDO SRAM	512K16=512kb x 16 P= PSEUDO SRAM	70ns	B = FBGA	I=Industrial (-40° C∼+85° C)	Indicates Pb and Halogen Free	Packing Type None:Tray TR:Reel



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